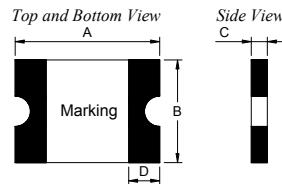


1、Physical Dimensions(size of 1206)

Unit:mm

Part Number	A		B		C		D	Marking
	Min	Max	Min	Max	Min	Max	Min	
KNSMD020/30	3.00	3.40	1.40	1.80	0.60	1.00	0.25	T02


2、Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I _{max} (A)	T _{trip} (Max time to trip)		P _{d typ} (W)	R _{min} (Ω)	R _{1max} (Ω)
	Current(A)	Time(S)							
KNSMD020/30	0.20	0.46	30	60	1.00	0.60	0.60	0.600	3.300

 I_H: Holding Current: maximum current at which the device will not trip in 25°C still air.

 I_T: Tripping Current minimum current at which the device will trip in 25°C still air.

 V_{max}: Maximum voltage device can withstand without damage at rated current.

 I_{max}: Maximum fault current device can withstand without damage at rated voltage.

 T_{trip}: Maximum time to trip(s) at assigned current.

 P_{d typ}: Rated working power.

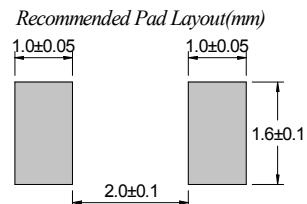
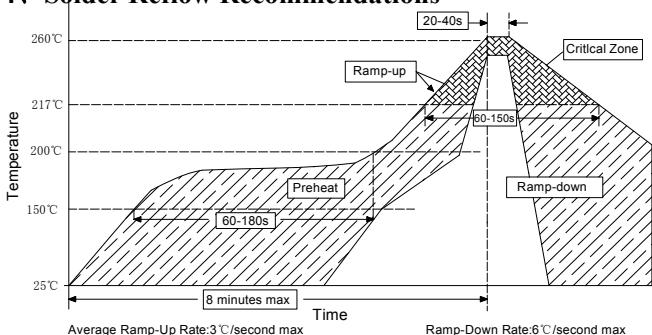
 R_{min}: Minimum resistance of device prior to trip at 25°C.

 R_{1max}: Maximum resistance of device is measured one hours post reflow at 25°C.

Notes: All electrical function test is conducted after PCB mounted.

3、Thermal Derating

KNSMD020/30	Maximum ambient operating temperature								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
Hold Current(A)	0.30	0.27	0.24	0.20	0.18	0.16	0.14	0.12	0.11
Trip Current(A)	0.69	0.62	0.55	0.46	0.41	0.37	0.32	0.28	0.25

4、Solder Reflow Recommendations


Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5、Package Information

Packing quantity: 4000PCS/Reel

Note: Reel packaging per EIA-481-1 standard